

FDMC86160ET100 N-Channel Shielded Gate PowerTrench[®] MOSFET 100 V, 43 A, 14 m Ω

Features

- Extended T_J rating to 175°C
- Shielded Gate MOSFET Technology
- Max $r_{DS(on)} = 14 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 9 \text{ A}$
- Max $r_{DS(on)}$ = 23 m Ω at V_{GS} = 6 V, I_D = 7 A
- High performance technology for extremely low r_{DS(on)}
- Termination is Lead-free and RoHS Compliant

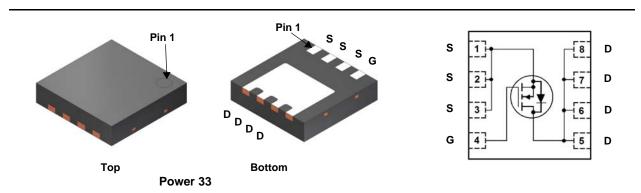


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance. This device is well suited for applications where ulta low $R_{DS\ (on)}$ is required in small spaces such as High performance VRM, POL and orring functions.

Applications

- Bridge Topologies
- Synchronous Rectifier



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter				Ratings	Units
V _{DS}	Drain to Source	/oltage			100	V
V _{GS}	Gate to Source V	/oltage			±20	V
ID	Drain Current	-Continuous	T _C = 25 °C	(Note 5)	43	
		-Continuous	T _C = 100 °C	(Note 5)	31	٨
		-Continuous	T _A = 25 °C	(Note 1a)	9	Α
		-Pulsed		(Note 4)	204	
E _{AS}	Single Pulse Ava	lanche Energy		(Note 3)	181	mJ
P _D	Power Dissipation		T _C = 25 °C	T _C = 25 °C		14/
	Power Dissipation		T _A = 25 °C	(Note 1a)	2.8	W
T _J , T _{STG}	Operating and Storage Junction Temperature Range				-55 to +175	°C

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	2.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	53	0/11

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC86160ET	FDMC86160ET100	Power33	13 "	12 mm	3000 units

	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V
∆BV _{DSS}	Breakdown Voltage Temperature			70		
ΔT_J	Coefficient	I_D = 250 $\mu A,$ referenced to 25 °C		73		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80 V, V_{GS} = 0 V$			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2	2.9	4	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage	$I_D = 250 \ \mu$ A, referenced to 25 °C		-9		mV/°C
ΔT_{J}	Temperature Coefficient	-		-0		11107 C
r _{DS(on)}		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 9 \text{ A}$		11.2	14	-
	Static Drain to Source On Resistance	$V_{GS} = 6 V$, $I_D = 7 A$		16	23	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 9 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		21	26	
9fs	Forward Transconductance	$V_{DD} = 10 \text{ V}, \ \text{I}_{D} = 9 \text{ A}$		43		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			968	1290	pF
C _{oss}	Output Capacitance	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		241	320	pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		11	20	pF
R _g	Gate Resistance		0.1	0.6	2.5	Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			9.7	19	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 9 A,		3.6	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		16	30	ns
t _f	Fall Time			3.4	10	ns
	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		15	22	nC
Q _{g(TOT)}	Tabal O ata Ohianna	$V_{\rm c} = 0 V_{\rm c} t_0 6 V_{\rm c} V_{\rm c}$		9.8	15	nC
	Total Gate Charge	$v_{\rm GS} = 0 \ v \ 10 \ 0 \ v \ v_{\rm DD} = 50 \ v,$				
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 6 V$ $V_{DD} = 50 V,$ $I_D = 9 A$		4.4		nC
Q _{g(TOT)} Q _{g(TOT)} Q _{gs} Q _{gd}	-	$V_{GS} = 0.0100 V$ $V_{DD} = 50 V$, $I_D = 9 A$		4.4 3.5		nC
Q _{g(TOT)} Q _{gs} Q _{gd}	Total Gate Charge	$V_{\rm GS} = 0.01000$ $V_{\rm DD} = 50.0$, $I_{\rm D} = 9.4$				
Q _{g(TOT)} Q _{gs} Q _{gd} Drain-So	Total Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics	V _{GS} = 0 V, I _S = 9 A (Note 2)			1.3	nC V
Q _{g(TOT)} Q _{gs} Q _{gd}	Total Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics Source to Drain Diode Forward Voltage	I _D = 9 A		3.5 0.79 0.72	1.2	nC
Q _{g(TOT)} Q _{gs} Q _{gd} Drain-So	Total Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics	V _{GS} = 0 V, I _S = 9 A (Note 2)		3.5 0.79		nC V

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 2. Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.</td>
 2000 μs, Duty cycle < 2.0%.</td>
 2000 μs, Duty cycle < 2.0%.</td>

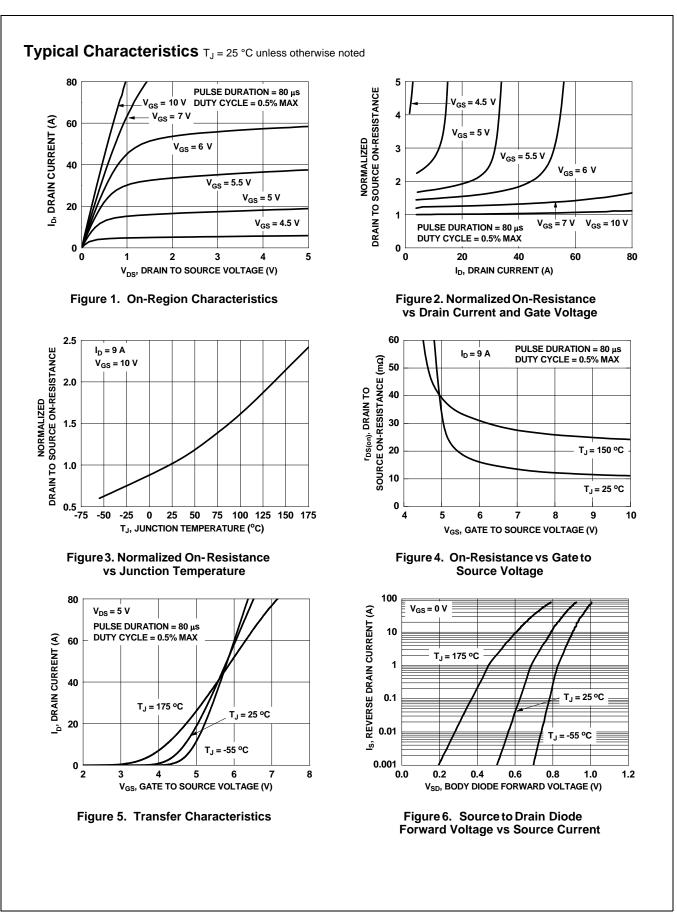
4. Pulsed Id please refer to Fig 11 SOA graph for more details.

5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

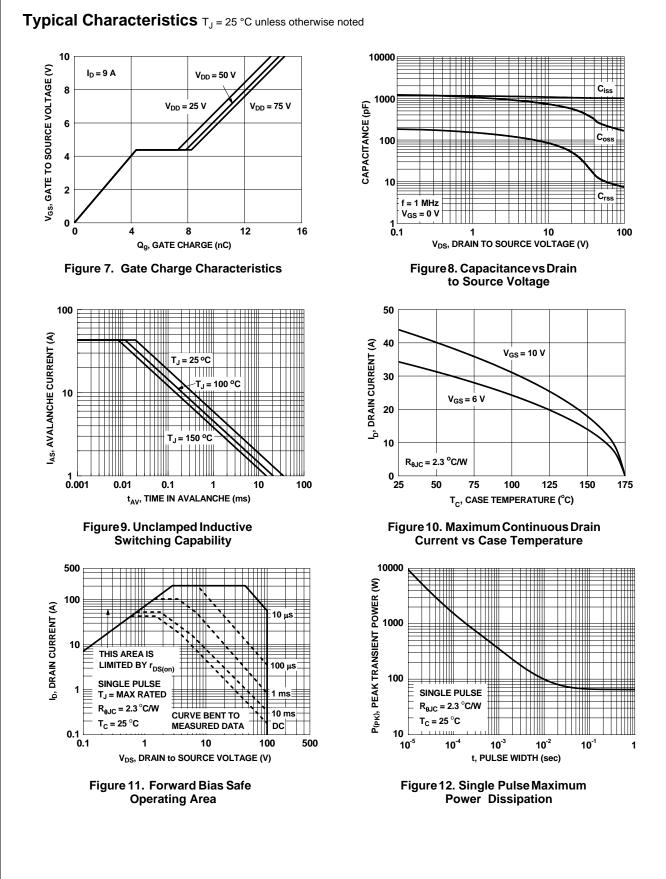
3. E_{AS} of 181 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 11 A, V_{DD} = 100 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 35 A.

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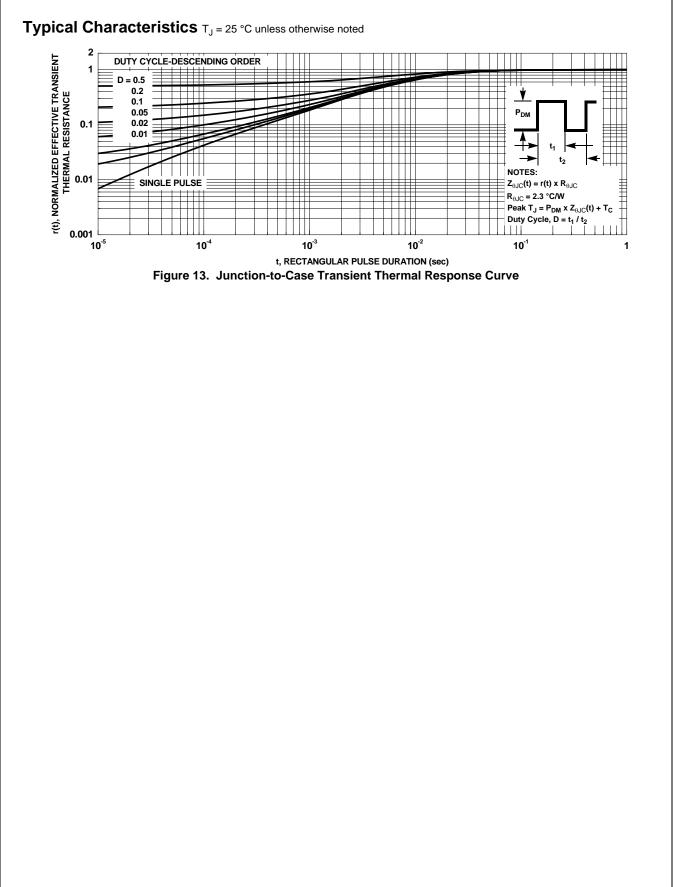
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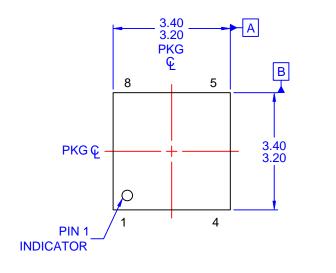


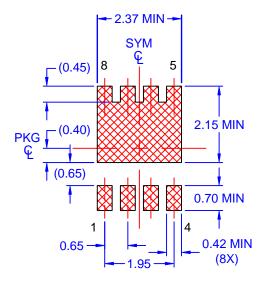
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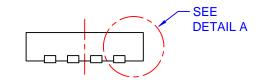
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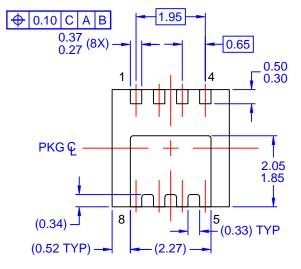


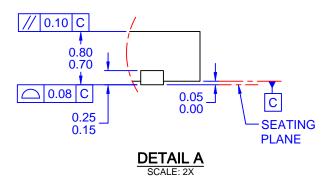












NOTES: UNLESS OTHERWISE SPECIFIED

- A) PACKAGE STANDARD REFERENCE: JEDEC MO-240, ISSUE A, VAR. BA, DATED OCTOBER 2002.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- E) DRAWING FILE NAME: PQFN08HREV1

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